

Features

- Core
 - ARM Cortex-M4 up to 96 MHz
 - Memory Protection Unit (MPU)
 - DSP Instructions
 - Floating Point Unit (FPU)
 - Thumb[®]-2 instruction set
- Memories
 - 512 Kbytes embedded Flash
 - 96 Kbytes embedded SRAM
- System
 - Embedded voltage regulator for single-supply operation
 - Power-on reset (POR) and Watchdog for safe operation
 - Quartz or ceramic resonator oscillators: 3 to 20 MHz with clock failure detection and 32.768 kHz for RTT or device clock
 - High-precision 8/16/24 MHz factory-trimmed internal RC oscillator. In-application trimming access for frequency adjustment
 - Slow clock internal RC oscillator as permanent low-power mode device clock
 - PLL range from 24 MHz to 96 MHz for device clock
 - 28 peripheral DMA (PDC) channels
 - 8 x 32-bit General-Purpose Backup Registers (GPBR)
 - 16 external interrupt lines
- Power consumption in Active mode
 - 102 μ A/MHz running Fibonacci in SRAM
- Low-power modes (typical value)
 - Wait mode down to 8 μ A
 - Wake-up time less than 5 μ s
 - Asynchronous partial wake-up (SleepWalking[™]) on UART and TWI
- Peripherals
 - One USART with SPI mode
 - Two Inter-IC Sound Controllers (I²S)
 - Two-way one-channel Pulse Density Modulation (PDM) (interfaces up to two microphones in PDM mode)
 - Two UARTs
 - Three Two-wire Interface (TWI) modules featuring two TWI masters and one high-speed TWI slave
 - One fast SPI at up to 24 Mbit/s
 - Two three-channel 16-bit Timer/Counters (TC) with Capture, Waveform, Compare and PWM modes
 - One 32-bit Real-Time Timer (RTT)
 - One 32-bit Real-Time Clock (RTC)

- I/O
 - Up to 38 I/O lines with external interrupt capability (edge or level), debouncing, glitch filtering and on-die series resistor termination. Individually programmable open-drain, pull-up and pull-down resistor and synchronous output
 - Two PIO Controllers provide control of up to 25 I/O lines
- Analog
 - One 8-channel ADC, resolution up to 12 bits, sampling rate up to 800 kSPS
- Package
 - 49-ball WLCSP
 - 100-pin LQFP, 14 x 14 mm, pitch 0.5 mm
- Temperature operating range
 - Industrial (-40° C to +85° C)

1. Configuration Summary

Table 1-1 summarizes the SAM G54 device configurations.

Table 1-1. Configuration Summary

Feature	SAM G54G19	SAM G54N19
Flash	512 Kbytes	512 Kbytes
SRAM	96 Kbytes	96 Kbytes
Package	WLCSP49	LQFP100
Number of PIOs	38	38
Event System	Yes	Yes
12-bit ADC	8 channels Performance: 800 kSPS at 10-bit resolution 200 kSPS at 11-bit resolution 50 kSPS at 12-bit resolution	8 channels Performance: 800 kSPS at 10-bit resolution 200 kSPS at 11-bit resolution 50 kSPS at 12-bit resolution
16-bit Timer	6 channels (3 external channels)	6 channels (3 external channels)
I2SC/PDM	2 / 1-channel 2-way	2 / 1-channel 2-way
PDC Channels	28	28
USART/UART	1/2	1/2
SPI	1	1
TWI	2 masters at 400 Kbits/s and 1 slave at 3.4 Mbit/s	2 masters at 400 Kbits/s and 1 slave at 3.4 Mbit/s

3. Signal Description

Table 3-1 provides details on the signal names classified by peripheral.

Table 3-1. Signal Description List

Signal Name	Function	Type	Active Level	Voltage Reference	Comments
Power Supplies					
VDDIO	Peripheral I/O Lines, Voltage Regulator, ADC Power Supply	Power	–	–	1.62V to 3.45V
VDDOUT	Voltage Regulator Output	Power	–	–	–
VDDCORE	Core Chip Power Supply	Power	–	–	Connected externally to VDDOUT
GND	Ground	Ground	–	–	–
Clocks, Oscillators and PLLs					
XIN	Main Oscillator Input	Input	–	VDDIO	Reset state: - PIO input - Internal pull-up disabled - Schmitt Trigger enabled
XOUT	Main Oscillator Output	Output	–	–	
XIN32	Slow Clock Oscillator Input	Input	–	VDDIO	
XOUT32	Slow Clock Oscillator Output	Output	–	–	
PCK0–PCK2	Programmable Clock Output	Output	–	–	Reset state: - PIO input - Internal pull-up enabled - Schmitt Trigger enabled
ICE and JTAG					
TCK	Test Clock	Input	–	VDDIO	No pull-up resistor
TDI	Test Data In	Input	–	VDDIO	No pull-up resistor
TDO	Test Data Out	Output	–	VDDIO	–
TRACESWO	Trace Asynchronous Data Out	Output	–	VDDIO	–
SWDIO	Serial Wire Input/Output	I/O	–	VDDIO	–
SWCLK	Serial Wire Clock	Input	–	VDDIO	–
TMS	Test Mode Select	Input	–	VDDIO	No pull-up resistor
JTAGSEL	JTAG Selection	Input	High	VDDIO	Pull-down resistor
Flash Memory					
ERASE	Flash and NVM Configuration Bits Erase Command	Input	High	VDDIO	Pull-down (15 kΩ) resistor
Reset/Test					
NRST	Microcontroller Reset	I/O	Low	VDDIO	Pull-up resistor
TST	Test Mode Select	Input	–	VDDIO	Pull-down resistor
Universal Asynchronous Receiver Transceiver - UART[x=0..1]					
URXDx	UART Receive Data x	Input	–	–	–

Table 3-1. Signal Description List (Continued)

Signal Name	Function	Type	Active Level	Voltage Reference	Comments
UTXDx	UART Transmit Data x	Output	–	–	–
PIO Controller - PIOA - PIOB					
PA0–PA24	Parallel I/O Controller A	I/O	–	VDDIO	Pulled-up input at reset. No pull-down for PA3/PA4/PA14.
PB0–PB12	Parallel I/O Controller B	I/O	–	VDDIO	Pulled-up input at reset
Wake-up Pins					
WKUP0–15	Wake-up Pin / External Interrupt	I/O	–	VDDIO	Wake-up pins are used also as External Interrupt
Universal Synchronous Asynchronous Receiver Transmitter USART					
SCK	USART Serial Clock	I/O	–	–	–
TXD	USART Transmit Data	I/O	–	–	–
RXD	USART Receive Data	Input	–	–	–
RTS	USART Request To Send	Output	–	–	–
CTS	USART Clear To Send	Input	–	–	–
Timer/Counter - TC[x=0..3]					
TCLKx	TC Channel x External Clock Input	Input	–	–	–
TIOAx	TC Channel x I/O Line A	I/O	–	–	–
TIOBx	TC Channel x I/O Line B	I/O	–	–	–
Serial Peripheral Interface - SPI					
MISO	Master In Slave Out	I/O	–	–	–
MOSI	Master Out Slave In	I/O	–	–	–
SPCK	SPI Serial Clock	I/O	–	–	High-speed pad
NPCS0	SPI Peripheral Chip Select 0	I/O	Low	–	–
NPCS1	SPI Peripheral Chip Select 1	Output	Low	–	–
Two-Wire Interface- TWI[x=0..1]					
TWDx	TWlx Two-wire Serial Data	I/O	–	–	High-speed pad for TWD0
TWCKx	TWlx Two-wire Serial Clock	I/O	–	–	High-speed pad for TWCK0
10-bit Analog-to-Digital Converter - ADCC					
AD0–AD7	Analog Inputs	Analog	–	–	–
ADTRG	ADC Trigger	Input	–	–	–
Inter-IC Sound Controller - I2SC[x=0..1]					
I2SMCKx	Master Clock	Output	–	–	–
I2SCKx	Serial Clock	I/O	–	–	–
I2SWSx	I ² S Word Select	I/O	–	–	–

Table 3-1. Signal Description List (Continued)

Signal Name	Function	Type	Active Level	Voltage Reference	Comments
I2SDIx	Serial Data Input	Input	–	–	–
I2SDOx	Serial Data Output	Output	–	–	–
PDMCLK0	Pulse Density Modulation Clock	Output	–	–	–
PDMDAT0	Pulse Density Modulation Data	Input	–	–	–

4. Package and Pinout

Table 4-1. SAM G54 Packages

Device	Package
SAM G54G19	WLCSP49
SAM G54N19	LQFP100

4.1 49-ball WLCSP Pinout

Table 4-2. SAM G54G19 49-ball WLCSP Pinout

A1	PA9	C1	VDDCORE	E1	PB2/AD6	G1	VDDIO
A2	GND	C2	PA11	E2	PB0/AD4	G2	VDDOUT
A3	PA24	C3	PA12	E3	PA18/AD1	G3	GND
A4	PB8/XOUT	C4	PB6	E4	PA14	G4	VDDIO
A5	PB9/XIN	C5	PA4	E5	PA10	G5	PA22
A6	PB4	C6	PA3	E6	TST	G6	PA15
A7	VDDIO	C7	PA0	E7	PA7/XIN32	G7	PA6
B1	PB11	D1	PA13	F1	PA20/AD3		
B2	PB5	D2	PB3/AD7	F2	PA19/AD2		
B3	PB7	D3	PB1/AD5	F3	PA17/AD0		
B4	PA2	D4	PB10	F4	PA21		
B5	JTAGSEL	D5	PA1	F5	PA23		
B6	NRST	D6	PA5	F6	PA16		
B7	PB12	D7	VDDCORE	F7	PA8/XOUT32		

4.2 100-lead LQFP Pinout

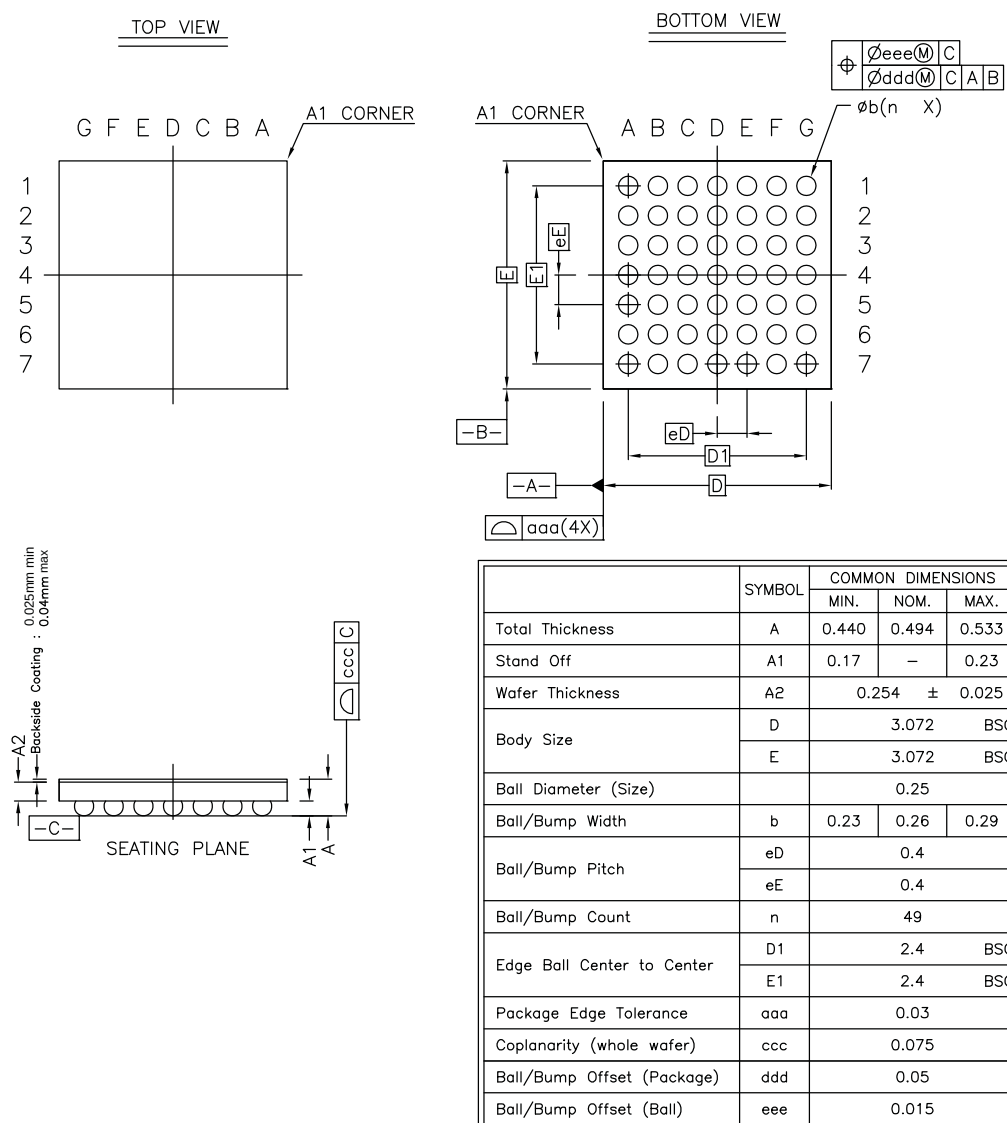
Table 4-3. SAM G54N19 100-pin LQFP Pinout

1	NC	26	NC	51	NC	76	NC
2	NC	27	NC	52	NC	77	NC
3	NC	28	PA6	53	PA17	78	NC
4	NC	29	VDDIO	54	PA18	79	PA9
5	VDDIO	30	PA16	55	PA19	80	PB5
6	VDDIO	31	PA15	56	PA20	81	GND
7	NRST	32	PA23	57	PB0	82	GND
8	PB12	33	NC	58	PB1	83	GND
9	PA4	34	NC	59	PB2	84	PB6
10	PA3	35	PA22	60	PB3	85	PB7
11	PA0	36	PA21	61	VDDIO	86	PA24
12	PA1	37	VDDIO	62	PA14	87	PB8
13	PA5	38	VDDIO	63	PA13	88	PB9
14	VDDIO	39	GND	64	PA12	89	VDDIO
15	VDDCORE	40	GND	65	PA11	90	PA2
16	VDDCORE	41	GND	66	VDDCORE	91	PB4
17	TEST	42	GND	67	VDDCORE	92	NC
18	PA7	43	GND	68	PB10	93	JTAGSEL
19	PA8	44	VDDOUT	69	PB11	94	VDDIO
20	GND	45	VDDOUT	70	GND	95	VDDIO
21	NC	46	VDDIO	71	GND	96	NC
22	NC	47	VDDIO	72	PA10	97	NC
23	NC	48	VDDIO	73	NC	98	NC
24	NC	49	NC	74	NC	99	NC
25	NC	50	NC	75	NC	100	NC

5. Mechanical Characteristics

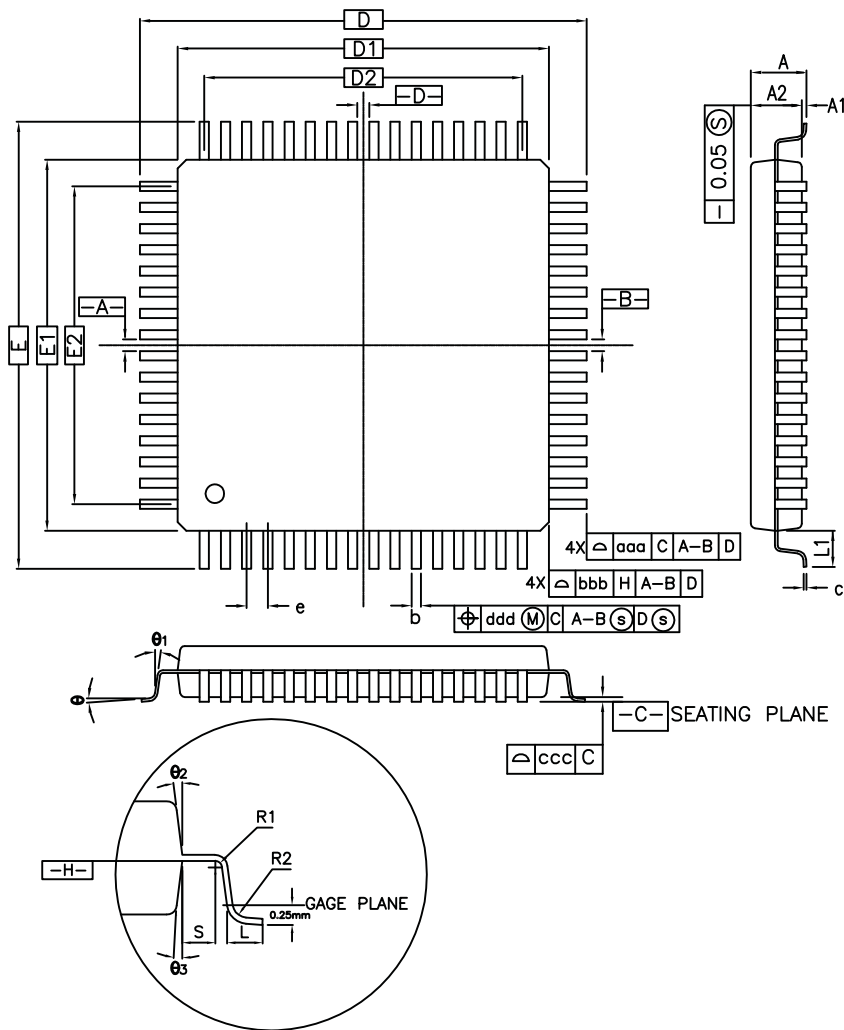
5.1 49-lead WLCSP Package

Figure 5-1. 49-lead WLCSP Package Mechanical Drawing



5.2 100-lead LQFP Package

Figure 5-2. 100-lead LQFP Package Mechanical Drawing



COTROL DIMENSIONS ARE IN MILLIMETERS.

SYMBOL	MILLIMETER			INCH		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	—	—	1.60	—	—	0.063
A1	0.05	—	0.15	0.002	—	0.006
A2	1.35	1.40	1.45	0.053	0.055	0.057
D	16.00 BSC.			0.630 BSC.		
D1	14.00 BSC.			0.551 BSC.		
E	16.00 BSC.			0.630 BSC.		
E1	14.00 BSC.			0.551 BSC.		
R2	0.08	—	0.20	0.003	—	0.008
R1	0.08	—	—	0.003	—	—
θ	0°	3.5°	7°	0°	3.5°	7°
θ ₁	0°	—	—	0°	—	—
θ ₂	11°	12°	13°	11°	12°	13°
θ ₃	11°	12°	13°	11°	12°	13°
c	0.09	—	0.20	0.004	—	0.008
L	0.45	0.60	0.75	0.018	0.024	0.030
L ₁	1.00 REF			0.039 REF		
S	0.20	—	—	0.008	—	—

SYMBOL	100L					
	MILLIMETER			INCH		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
b	0.17	0.20	0.27	0.007	0.008	0.011
e	0.50 BSC.			0.020 BSC.		
D2	12.00			0.472		
E2	12.00			0.472		
aaa	0.20			0.008		
bbb	0.20			0.008		
ccc	0.08			0.003		
ddd	0.08			0.003		

6. Ordering Information

Table 6-1. SAM G54 Ordering Codes

Ordering Code	MRL	Flash (Kbytes)	Package	Carrier Type	Temperature Operating Range
ATSAMG54G19B-UUT	B	512	WLCSP49	Tape and Reel	Industrial -40°C to 85°C
ATSAMG54N19B-AU	B	512	LQFP100	Tape and Reel	Industrial -40°C to 85°C

7. Revision History

In the tables that follow, the most recent version of the document appears first.

Table 7-1. SAM G54 Datasheet Rev. 11266AS Revision History

Doc. Date	Changes
16-Dec-14	First issue.



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